TOSHIBA LED Lamp

TLRM1050(T20),TLRMM1050(T20),TLSM1050(T20), TLOM1050(T20),TLYM1050(T20)

Panel Circuit Indicator

- $5.2 \text{ (L)} \times 5.2 \text{ (W)} \times 4.0 \text{ (H)} \text{ mm}$
- ϕ 3.6 mm transparent lens top type
- InGaAlP LEDs
- High luminous intensity and low power consumption.
- Color: red, orange, yellow
- High operating temperature

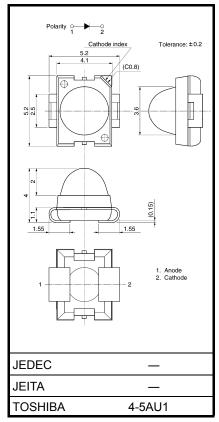
 T_{opr} : -40 to 100°C / T_{stg} : -40 to 110°C

- Surface-mount devices
- Standard embossed tape packing 8-mm component pitch: T20 (400 pcs/reel)
- Reflow-soldering is available
- Applications: amusement, message signboards, automotive interiors and exteriors, etc.

Color and Material

Part Number	Color	Material
TLRM1050	Red	
TLRMM1050	Red	
TLSM1050	Red	InGaAlP
TLOM1050	Orange	
TLYM1050	Yellow	

Unit: mm



Weight: 0.085 g (typ.)

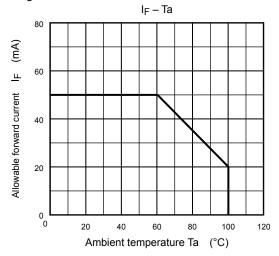
Absolute Maximum Ratings (Ta = 25°C)

Product Name	Forward Current I _F (mA)	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature Topr (℃)	Storage Temperature Tstg (℃)
TLRM1050					
TLRMM1050					
TLSM1050	50	4	135	-40 to 100	-40 to 110
TLOM1050					
TLYM1050					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

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Note 1: Forward current derating



Electrical Characteristics (Ta = 25°C)

Product Name	Fo	orward Vo	oltage \	٧F	Reverse C	rse Current IR	
Product Name	Min	Тур.	Max	lF	Max	V_{R}	
TLRM1050	2.0	2.3	2.7				
TLRMM1050	2.0	2.3	2.7			4	
TLSM1050	2.0	2.3	2.7	20	10		
TLOM1050	2.0	2.3	2.7				
TLYM1050	2.0	2.3	2.7				
Unit		V		mA	μΑ	V	

Optical Characteristics-1 (Ta = 25°C)

Product Name	Luminous Intensity I _V				Corresponding brightness
Floduct Name	Min	Тур.	Max	lF	rank sign (Note 2)
TLRM1050	630	1800	3200		VA/WA/XA
TLRMM1050	1000	2000	5000		WA/XA/YA
TLSM1050	1600	2800	8000	20	XA/YA/ZA
TLOM1050	1600	3500	8000		XA/YA/ZA
TLYM1050	1600	3000	8000		XA/YA/ZA
Unit	mcd			mA	

Note 2: The specification on the above table is used for Iv classification of LEDs in Toshiba facility. Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

Brightness rank				
Rank sign	ank sign Min Max			
VA	630	1250		
WA	1000	2000		
XA	1600	3200		
YA	2500	5000		
ZA	4000	8000		
Unit	mcd	mcd		

Optical Characteristics-2 (Ta = 25°C)

	Emission Spectrum							
Product Name	Peak Emission Wavelength λ_p		Δλ	Dominant Wavelength λ_d			-d	
	Min	Тур.	Max	Тур	Min	Тур.	Max	IF
TLRM1050	_	644	_	14	624	630	638	
TLRMM1050	_	636	_	14	620	626	634	
TLSM1050	_	623	_	14	607	613	621	20
TLOM1050	_	612	_	14	599	605	613	
TLYM1050	_	592	_	13	583	590	595	
Unit		nm		nm		nm		mA

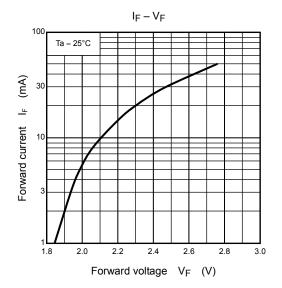
Caution

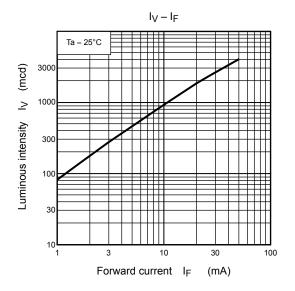
• This product is a product developed as a display source of light usage, and the measurement standard matched to the sensitivity of human eyes is applied.

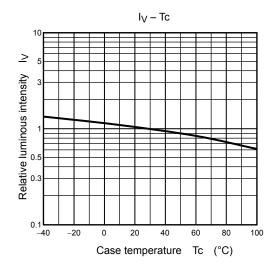
3

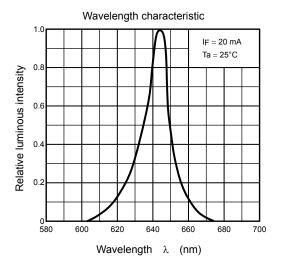
Therefore, functional usages (source of light for the sensor and the communication) other than the source of light for the display is not intended.

TLRM1050



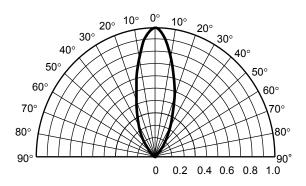




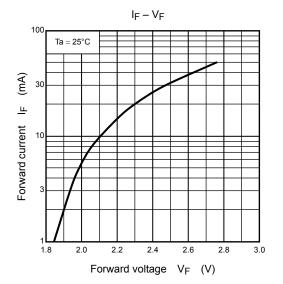


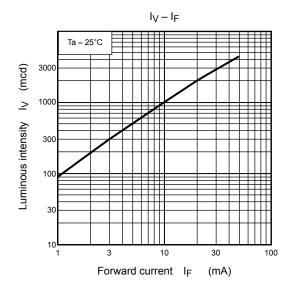
Radiation pattern

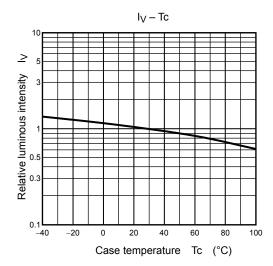
 $Ta=25^{\circ}C$

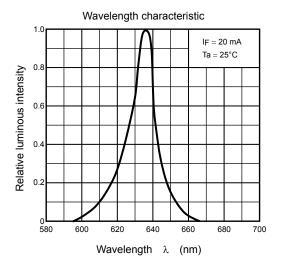


TLRMM1050



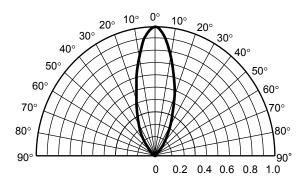




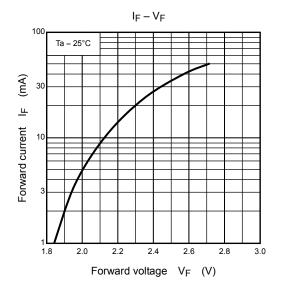


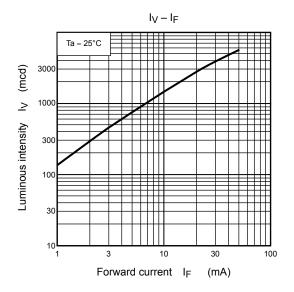
Radiation pattern

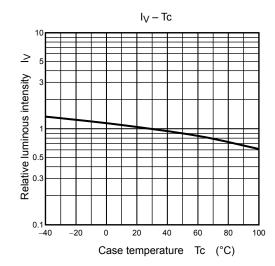
 $Ta = 25^{\circ}C$

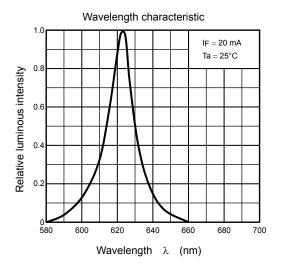


TLSM1050



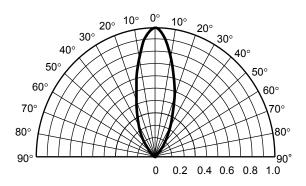




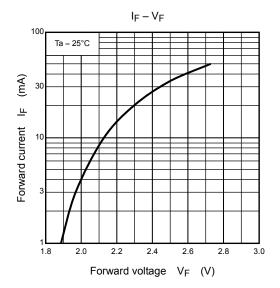


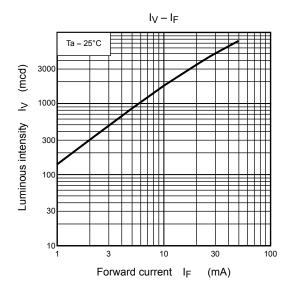
Radiation pattern

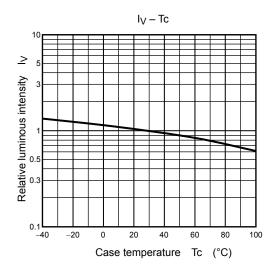
Ta = 25°C

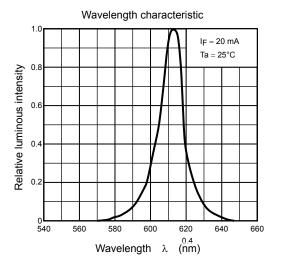


TLOM1050



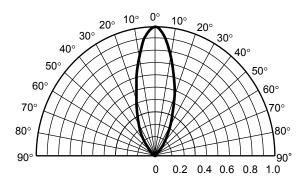




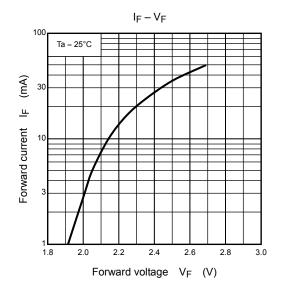


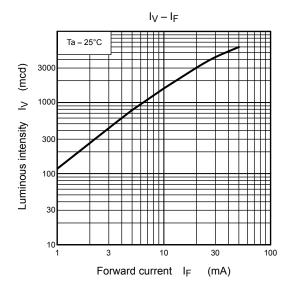
Radiation pattern

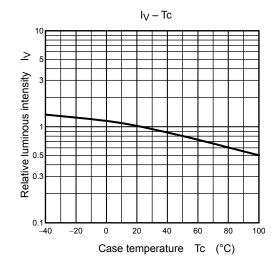
 $Ta=25^{\circ}C$

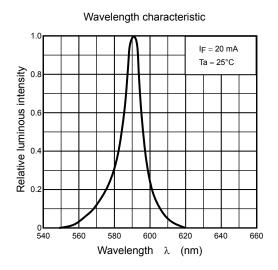


TLYM1050



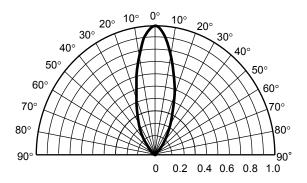






Radiation pattern

 $Ta=25^{\circ}C$





Packaging

These LED devices are packed in an aluminum envelope with silica gel and a moisture indicator to prevent moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

- 1. This moisture-proof bag may be stored unopened for up to 12 months under the following conditions. Temperature: 5°C to 30°C
 - Humidity: 90% (max)
- 2. After the moisture-proof bag has been opened, the devices should be assembled within 168 hours in an environment of 5° C to 30° C/70% RH or below.
- 3. If, upon opening, the moisture indicator card shows humidity of 30% or above (when the indication color changes to pink) or the expiration date has passed, the devices should be baked while packed in the tape reel.

After baking, use the baked devices within 72 hours, but perform baking only once.

Baking conditions: 60 ±5°C, for 12 to 24 hours.

- Expiration date: 12 months from the sealing date, which is imprinted on the same side as this label.
- 4. Repeated baking may cause the peeling strength of the tape to change, leading to trouble in mounting. Also, be sure to prevent damage to the device from static electricity during the baking process.
- 5. Any breakage in the laminate packing material will cause the hermetically of the product to deteriorate. Do not toss or drop the packed devices.

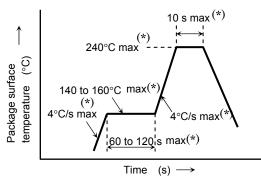
Mounting Method

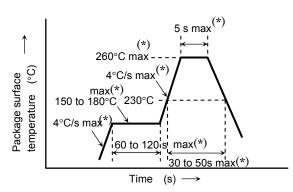
Soldering

• Reflow soldering (example)

Temperature profile for Pb soldering (example)

Temperature profile for Pb-free soldering (example)





- The product is evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Perform the first reflow soldering in accordance with the above temperature profile and within 168 hours of opening the package.
- Second time reflow

In case of second reflow soldering should be performed within 168 hours of the first reflow under the above conditions. Storage conditions before the second reflow soldering: 5 to 30°C, 70% RH max

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- Do not perform flow soldering and dip soldering.
- · Make any necessary soldering corrections manually.

(only once at each soldering point)

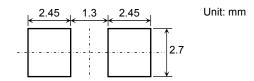
Soldering iron: Less than 25 W

Temperature: Less than 350°C or less

Time: within 3 s (Up to one time per place)

2009-07-09

Recommended soldering pattern



Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents. Our dipping tests (carried out under the recommended conditions) confirm that these solvents have no effect on semiconductor devices. In selecting the cleaning solvent you will actually use, be sure to take into account the cleaning conditions and usage conditions.

Cleaning Solvent
ASAHI CLEAN AK-225AES
KAO CLEAN THROUGH 750H
PINE ALPHA ST-100S

Manufacturer ASAHI GLASS KAO ARAKAWA CHEMICAL

Precautions When Mounting

Do not apply force to plastic parts of the LED under high-temperature conditions.

The LED plastic is easily scratched. Avoid friction between plastic parts and hard objects or materials.

When installing the PCB in a product, ensure that the device does not come into contact with other components.

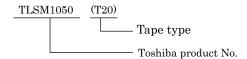
This product doesn't apply mounting that solder flow. Please mount on recommended reflow solder mounting condition.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (This method, however, does not apply to products whose electrical characteristics differ from standard Toshiba specifications.)

- (1) Tape Type: T20 (8-mm pitch)
- (2) Example



2. Handling precautions

Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

(a) In process, taping materials may sustain an electrostatic charge, use an ionizer to neutralize the ions.

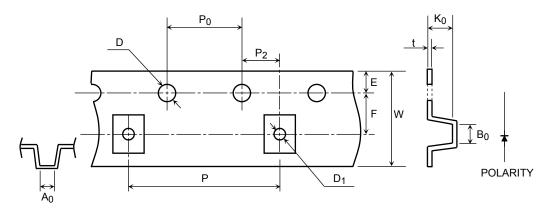
10

(b) For transport and temporary storage of devices, use containers(boxes, jigs, and bags) that are made of anti-static materials or of materials that dissipate electrostatic electricity.

3. Tape dimensions

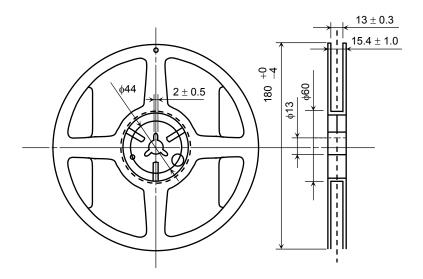
Symbol	Dimension	Tolerance
D	1.5	+0.1/-0
E	1.75	±0.1
P ₀	4.0	±0.1
t	0.4	±0.05
F	5.5	±0.05
D ₁	1.6	±0.1

		(Unit: mm)
Symbol	Dimension	Tolerance
P ₂	2.0	±0.05
W	12.0	±0.2
Р	8.0	±0.1
A ₀	5.5	±0.1
B ₀	5.5	±0.1
K ₀	4.4	±0.1

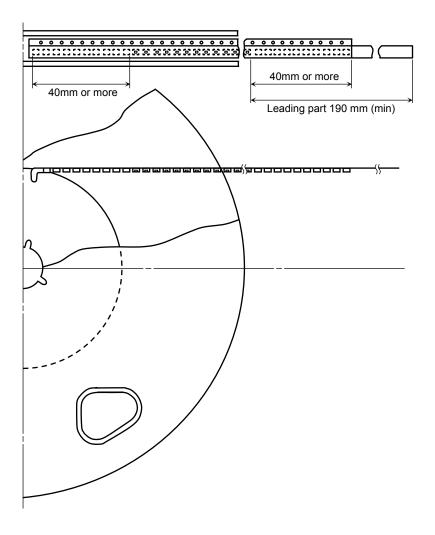


4. Reel dimensions

Unit: mm



5. Leader and trailer section of tape



6. Packing form

(1) Packing quantity

Reel	400 pcs
Carton	2,000 pcs

(2) Packing form: Each reel is sealed in an aluminum pack with silica gel.

7. Label format

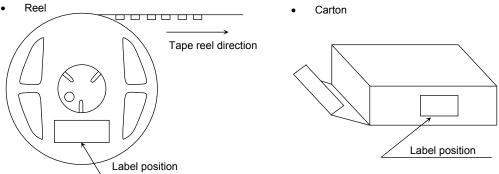
(1) Example: TLSM1050 (T20)

P/N:				TOSHIBA
TYPE	TLSM1050			
ADDC	(T20)	Q'TY	400 pcs	
	ber Key code for TSB SYMBOL)	32C	400	

Use under 5-30degC/70%RH within 168h



(2) Label location



• The aluminum package in which the reel is supplied also has a copy of the label attached to the center of one side.

*The Lot Number includes the following information.

Example: $\underline{270} \ \underline{9} \ \underline{D} \ \underline{3} \ \underline{G} \rightarrow \text{"Packaged April 27, 2009"}$

- a bcde
- a: Domestic ID
- b: Last digit of the year (CE): "0" (Y2000), "1" (Y2001), "2" (Y2002) to "9" (Y2009)

Repeated for each decade

- c: Month: "A" (Jan), "B" (Feb), "C" (Mar) to "L" (Dec)
- d: Decade of the month: "1" (First), "2" (Middle), "3" (Last)
- e: Day in d above: "A" (1st), "B" (2nd), "C" (3rd) to "J" (9th), "K" (10th)
 - "L" denotes the 31st of the month
 - "I" is not used to denote a day in this date system



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 Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for
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